

Claim Amendments

1. (Currently Amended) A dielectric barrier discharge plasma cell, comprising:

a conductor adapted to receive an alternating current voltage; and

a dielectric spaced apart from said conductor, said dielectric comprising:

a dielectric substrate having a first surface nearer to said conductor and a second surface, opposite said first surface and farther away from said conductor; [and]

a conductive coating on said second surface of said dielectric substrate, adapted to receive the [an] alternating current voltage; and

a protective coating covering the conductive coating;

wherein said cell [is generally rectangular in cross section,] is adapted to generate plasma in the space between said conductor and said dielectric in response to the application of the alternating current voltage, and is configured for stacking with another substantially similar dielectric discharge plasma cell.
2. (Original) The dielectric barrier discharge plasma cell of claim 1 wherein said dielectric and said conductor are uniformly spaced from one another.
3. (Original) The dielectric barrier discharge plasma cell of claim 1 further comprising a transformer and wherein said alternating current voltage is raised from an input voltage to an operational voltage by said transformer.
4. (Original) The dielectric barrier discharge plasma cell of claim 1 wherein said conductor consists of a conductor substrate and a conductor coating layer.

5. (Original) The dielectric barrier discharge plasma cell of claim 4 wherein said conductor substrate comprises an electrode.

6. (Original) The dielectric barrier discharge plasma cell of claim 4 wherein said conductor substrate comprises stainless steel.

7. (Original) The dielectric barrier discharge plasma cell of claim 4 wherein said conductor substrate comprises aluminum.

8. (Original) The dielectric barrier discharge plasma cell of claim 4 wherein said conductor substrate comprises copper.

9. (Original) The dielectric barrier discharge plasma cell of claim 4 wherein said conductor coating layer comprises a catalyst.

10. (Original) The dielectric barrier discharge plasma cell of claim 9 wherein said catalyst comprises nickel.

11. (Original) The dielectric barrier discharge plasma cell of claim 1 further comprising a plurality of spacer elements for spacing said dielectric and said conductor.

12. (Currently Canceled)

13. (Currently Amended) The dielectric barrier discharge plasma cell of claim 1 [12] further comprising an adhesion layer between said conductive coating and said dielectric substrate.
14. (Original) The dielectric barrier discharge plasma cell of claim 13 wherein said adhesion layer comprises titanium.
15. (Original) The dielectric barrier discharge plasma cell of claim 13 wherein said adhesion layer comprises chromium.
16. (Original) The dielectric barrier discharge plasma cell of claim 13 wherein said adhesion layer is about 400 angstroms to about 600 angstroms in thickness.
17. (Original) The dielectric barrier discharge plasma cell of claim 13 wherein said adhesion layer is sputter coated onto said dielectric substrate.
18. (Original) The dielectric barrier discharge plasma cell of claim 1 wherein said conductive coating comprises copper.
19. (Original) The dielectric barrier discharge plasma cell of claim 1 wherein said conductive coating is about 25 microns to 100 microns in thickness.
20. (Original) The dielectric barrier discharge plasma cell of claim 13 wherein said conductive coating is sputter coated onto said adhesion layer.

21. (Original) The dielectric barrier discharge plasma cell of claim 13 wherein said conductive coating is sputter coated onto said adhesion layer for about 2000 angstroms in thickness and then plated onto said adhesion layer.

22. (Currently Amended) The dielectric barrier discharge plasma cell of claim 1[2] wherein said protective layer comprises nickel.

23. (Currently Amended) The dielectric barrier discharge plasma cell of claim 1[2] wherein said protective layer comprises a tin based solder alloy.

24. (Currently Amended) The dielectric barrier discharge plasma cell of claim 1[2] wherein said protective layer is about 25 microns to about 100 microns in thickness.

25. (Currently Amended) The dielectric barrier discharge plasma cell of claim 1[2] wherein said protective layer is plated onto said conductive coating.

26. (Original) The dielectric barrier discharge plasma cell of claim 1 wherein said second surface of said dielectric substrate is treated such that said conductive coating adheres thereto.

27. (Original) The dielectric barrier discharge plasma cell of claim 26 wherein said second surface of said dielectric substrate is sand blasted.

28. (Original) The dielectric barrier discharge plasma cell of claim 26 wherein said second surface of said dielectric substrate is ground.

29. (Original) The dielectric barrier discharge plasma cell of claim 2 wherein said dielectric and said conductor are arranged as parallel plates.

30. (Original) The dielectric barrier discharge plasma cell of claim 29 wherein said dielectric and said conductor are corrugated.

31. (Original) The dielectric barrier discharge plasma cell of claim 1 wherein said dielectric is cylindrical.

32. (Original) The dielectric barrier discharge plasma cell of claim 31 wherein said conductor is coaxial with said dielectric.

33. (Original) The dielectric barrier discharge plasma cell of claim 31 wherein said conductor comprises at least one cork screw shaped element.

34. (Original) The dielectric barrier discharge plasma cell of claim 33 wherein said cork screw shaped element comprises a thin electrode.

35. (Previously Presented) A dielectric barrier discharge plasma system, comprising: a plurality of dielectric barrier discharge plasma cells, wherein each of said dielectric barrier discharge plasma cells comprises: a conductor adapted to receive an alternating current voltage; and a dielectric spaced apart from said conductor, said dielectric comprising: a dielectric substrate having a first surface nearer to said conductor and a second surface, opposite said first surface and farther from said conductor; and a conductive coating on said second surface of said dielectric substrate, adapted to receive an alternating current voltage; and wherein said cells are generally rectangular in cross-section and are adapted to generate plasma in the space between said conductor and said dielectric; and wherein said plurality of dielectric barrier discharge

plasma cells are arranged radially.

36. (Currently Amended) A dielectric barrier discharge plasma system, comprising: a plurality of dielectric barrier discharge plasma cells, wherein each of said dielectric barrier discharge plasma cells comprises: a conductor adapted to receive an alternating current voltage; and a dielectric spaced apart from said conductor, said dielectric comprising: a dielectric substrate having a first surface nearer to said conductor and a second surface, opposite said first surface and farther from said conductor; [and] a conductive coating on said second surface of said dielectric substrate, adapted to receive an alternating current voltage; and a protective layer covering the conductive coating; and wherein said cells are generally rectangular in cross-section and are adapted to generate plasma in the space between said conductor and said dielectric; and wherein said plurality of dielectric barrier discharge plasma cells are stacked.

37. (Newly Presented) An HVAC system for a building, comprising:
a safety system; and
a dielectric barrier discharge plasma cell configured to triggered by the safety system.

38. (Newly Presented) The HVAC system according to claim 37, wherein the dielectric barrier discharge plasma cell further comprises:

a conductor adapted to receive an alternating current voltage; and
a dielectric spaced apart from said conductor, said dielectric comprising:
a dielectric substrate having a first surface nearer to said conductor and a second surface, opposite said first surface and farther away from said conductor;
a conductive coating on said second surface of said dielectric substrate;
and

a protective coating covering the conductive coating; wherein said dielectric barrier discharge plasma cell is adapted to generate plasma in the space between said conductor and said dielectric in response to the application of the alternating current voltage, and is configured for stacking with another substantially similar dielectric discharge plasma cell.

39. (Newly Presented) The dielectric barrier discharge plasma cell according to claim 38, wherein said dielectric and said conductor are uniformly spaced from one another.

40. (Newly Presented) The dielectric barrier discharge plasma cell according to claim 38, further comprising a transformer and wherein said alternating current voltage is raised from an input voltage to an operational voltage by said transformer.

41. (Newly Presented) The dielectric barrier discharge plasma cell according to claim 38, wherein said conductor consists of a conductor substrate and a conductor coating layer.

42. (Newly Presented) The dielectric barrier discharge plasma cell of claim 41 wherein said conductor substrate comprises an electrode.

43. (Newly Presented) The dielectric barrier discharge plasma cell of claim 41 wherein said conductor substrate comprises stainless steel.

44. (Newly Presented) The dielectric barrier discharge plasma cell of claim 41 wherein said conductor substrate comprises aluminum.

45. (Newly Presented) The dielectric barrier discharge plasma cell of claim 41

wherein said conductor substrate comprises copper.

46. (Newly Presented) The dielectric barrier discharge plasma cell of claim 41 wherein said conductor coating layer comprises a catalyst.

47. (Newly Presented) The dielectric barrier discharge plasma cell of claim 46 wherein said catalyst comprises nickel.

48. (Newly Presented) The dielectric barrier discharge plasma cell of claim 38 further comprising a plurality of spacer elements for spacing said dielectric and said conductor.

49. (Newly Presented) A building, comprising:
a control system;
an HVAC system; and
a plurality of dielectric barrier discharge plasma cells integrated with the HVAC system and configured to be triggered by the control system.

50. (Newly Presented) The building of claim 49, wherein the plurality of dielectric barrier discharge plasma cells are stacked.

51. (Newly Presented) The building of claim 49, wherein the plurality of dielectric barrier discharge plasma cells are in a radial configuration.

52. (Newly Presented) The building of claim 49, wherein each dielectric barrier discharge plasma cell comprises a dielectric that is tubular.

53. (Newly Presented) The building of claim 52, wherein each dielectric barrier discharge plasma cell comprises of a plurality of electrodes.

54. (Newly Presented) An apparatus configured to neutralize harmful agents; comprising:

a mobile cart; and

a plurality of dielectric barrier discharge plasma cells, wherein the plurality of dielectric barrier discharge plasma cells are mounted on the mobile cart.

55. (Newly Presented) The apparatus of claim 54, wherein the plurality of dielectric barrier discharge plasma cells are stacked.

56. (Newly Presented) The apparatus of claim 54, wherein the plurality of dielectric barrier discharge plasma cells are in a radial configuration.

57. (Newly Presented) The apparatus of claim 54, wherein each dielectric barrier discharge plasma cell comprises a dielectric that is tubular.